



# NPN SILICON TRANSISTOR

Qualified per MIL-PRF-19500/366

## DESCRIPTION

This family of 2N3498L thru 2N3501L epitaxial planar transistors are military qualified up to a JANS level for high-reliability applications. These devices are also available in TO-39 and low profile U4 packaging. Microsemi also offers numerous other transistor products to meet higher and lower power ratings with various switching speed requirements in both through-hole and surface-mount packages.

Important: For the latest information, visit our website http://www.microsemi.com.

## **FEATURES**

- JEDEC registered 2N3498 through 2N3501 series.
- JAN, JANTX, JANTXV, and JANS qualifications are available per MIL-PRF-19500/366. (See <u>part nomenclature</u> for all available options.)
- RoHS compliant versions available (commercial grade only).

## **APPLICATIONS / BENEFITS**

- General purpose transistors for medium power applications requiring high frequency switching.
- Low package profile.
- Military and other high-reliability applications.

## MAXIMUM RATINGS

Parameters / Test Conditions	Symbol	2N3498L 2N3499L	2N3500L 2N3501L	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	100	150	V
Collector-Base Voltage		100	150	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	6.0	V
Collector Current	Ι <sub>C</sub>	500	300	mA
Thermal Resistance Junction-to-Ambient	$R_{\Theta JA}$	175		°C/W
Thermal Resistance Junction-to-Case	R <sub>eJC</sub>	30		°C/W
Total Power Dissipation	Ρτ	1.0 5.0		W
Operating & Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +200		°C

Notes: 1. See figure 1.

2. See figure 2.

<u>Qualified Levels</u>: JAN, JANTX, JANTXV and JANS



TO-5 Package

Also available in:

TO-39 (TO-205AD) package (leaded) 2N3498 - 2N3501

U4 package (surface mount) 2N3498U4 – 2N3501U4

MSC – Lawrence

6 Lake Street, Lawrence, MA 01841 Tel: 1-800-446-1158 or (978) 620-2600 Fax: (978) 689-0803

MSC – Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

Website:

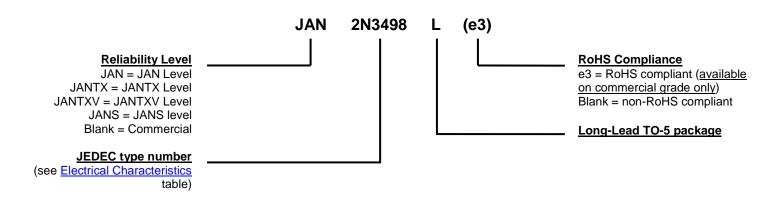
www.microsemi.com



# **MECHANICAL and PACKAGING**

- CASE: Hermetically sealed, kovar base, nickel cap.
- TERMINALS: Leads are kovar, nickel plated, and finish is solder dip (Sn63/Pb37). Can be RoHS compliant with pure matte-tin (commercial grade only).
- MARKING: Part number, date code, manufacturer's ID.
- WEIGHT: Approximately 1.14 grams.
- See Package Dimensions on last page.

## PART NOMENCLATURE



	SYMBOLS & DEFINITIONS				
Symbol	I Definition				
C <sub>obo</sub>	Common-base open-circuit output capacitance				
I <sub>CEO</sub>	Collector cutoff current, base open				
I <sub>CEX</sub>	Collector cutoff current, circuit between base and emitter				
I <sub>EBO</sub>	Emitter cutoff current, collector open				
h <sub>FE</sub>	Common-emitter static forward current transfer ratio				
V <sub>CEO</sub>	Collector-emitter voltage, base open				
V <sub>CBO</sub>	Collector-emitter voltage, emitter open				
V <sub>EBO</sub>	Emitter-base voltage, collector open				



# **ELECTRICAL CHARACTERISTICS** @ $T_A = +25$ °C, unless otherwise noted

Characteristic		Symbol	Min.	Max.	Unit
OFF CHARACTERISTICS	·			•	
Collector-Emitter Breakdown Voltage					
$I_{\rm C}$ = 10 mA, pulsed	2N3498L, 2N3499L 2N3500L, 2N3501L	$V_{(BR)CEO}$	100 150		V
Collector-Base Cutoff Current					
V <sub>CB</sub> = 50 V	2N3498L, 2N3499L	I <sub>CBO</sub>		50	nA
V <sub>CB</sub> = 75 V	2N3500L, 2N3501L			50	nA
V <sub>CB</sub> = 100 V	2N3498L, 2N3499L			10	μA
V <sub>CB</sub> = 150 V	2N3500L, 2N3501L			10	μA
Emitter-Base Cutoff Current					
V <sub>EB</sub> = 4.0 V		I <sub>EBO</sub>		25	nA
$V_{EB} = 6.0 V$				10	μA

# ON CHARACTERISTICS (1)

Forward-Current Transfer Ratio					
$I_{C} = 0.1 \text{ mA}, V_{CE} = 10 \text{ V}$	2N3498L, 2N3500L	h <sub>FE</sub>	20		
	2N3499L, 2N3501L		35		
$I_{C} = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$	2N3498L, 2N3500L		25 50		
	2N3499L, 2N3501L		35		
$I_{C} = 10 \text{ mA}, V_{CE} = 10 \text{ V}$	2N3498L, 2N3500L 2N3499L, 2N3501L		75		
I <sub>C</sub> = 150 mA, V <sub>CE</sub> = 10 V	2N3498L, 2N3500L		40	120	
$i_{\rm C} = 150  {\rm mA},  v_{\rm CE} = 10  {\rm v}$	2N3499L, 2N3501L		100	300	
$I_{C} = 300 \text{ mA}, V_{CE} = 10 \text{ V}$	2N3500L		15		
	2N3501L		20		
$I_{C} = 500 \text{ mA}, V_{CE} = 10 \text{ V}$	2N3498L		15		
	2N3499L		20		
Collector-Emitter Saturation Voltage					
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1.0 mA	All Types	V <sub>CE(sat)</sub>		0.2	V
I <sub>C</sub> = 300 mA, I <sub>B</sub> = 30 mA	2N3498L, 2N3499L			0.6	
$I_{\rm C} = 150$ mA, $I_{\rm B} = 15$ mA	2N3500L, 2N3501L			0.4	
Base-Emitter Saturation Voltage					
$I_{\rm C} = 10$ mA, $I_{\rm B} = 1.0$ mA	All Types	V <sub>BE(sat)</sub>		0.8	V
$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 30 \text{ mA}$	2N3498L, 2N3499L			1.4	
$I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$	2N3500L, 2N3501L			1.2	

### **DYNAMIC CHARACTERISTICS**

Forward Current Transfer Ratio, Magnitude $I_{C} = 20 \text{ mA}, V_{CE} = 20 \text{ V}, f = 100 \text{ MHz}$		h <sub>fe</sub>	1.5	8.0	
CB is i, E e,	98L, 2N3499L 90L, 2N3501L	C <sub>obo</sub>		10 8.0	pF
Input Capacitance V <sub>EB</sub> = 0.5 V, I <sub>C</sub> = 0, 100 kHz $\leq$ f $\leq$ 1.0 MHz		C <sub>ibo</sub>		80	pF

(1) Pulse Test: pulse width = 300  $\mu$ s, duty cycle  $\leq$  2.0%.



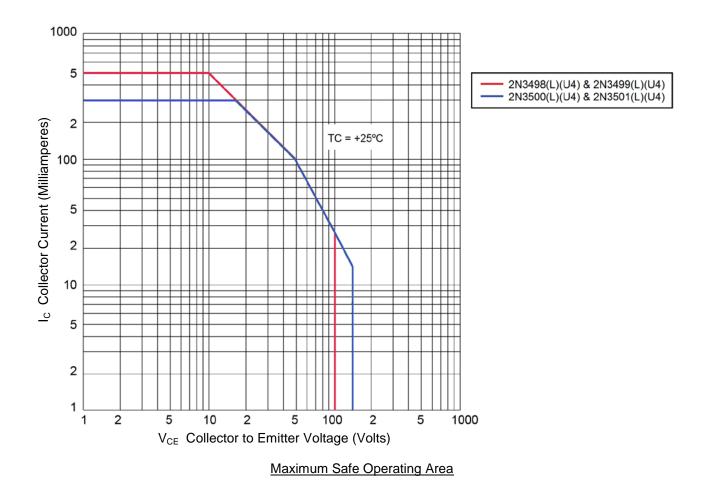
## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = +25 °C, unless otherwise noted)

## SWITCHING CHARACTERISTICS

Characteristic	Symbol	Min.	Max.	Unit
Turn-On Time V <sub>FB</sub> = 5 V; I <sub>C</sub> = 150 mA; I <sub>B1</sub> = 15 mA	ton		115	ns
Turn-Off Time	t "		1150	20
I <sub>C</sub> = 150 mA; I <sub>B1</sub> = I <sub>B2</sub> = -15 mA	'off		1150	ns

## SAFE OPERATING AREA (See SOA figure and reference MIL-STD-750 method 3053)

DC Tests	
$T_{C}$ = +25 °C, $t_{r} \ge$ 10 ns; 1 Cycle, t = 1.0	S
Test 1	
$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 500 \text{ mA}$	2N3498L, 2N3499L
V <sub>CE</sub> = 16.67 V, I <sub>C</sub> = 300 mA	2N3500L, 2N3501L
Test 2	
$V_{CE} = 50 \text{ V}, \text{ I}_{C} = 100 \text{ mA}$	All Types
Test 3	
$V_{CE} = 80 \text{ V}, \text{ I}_{C} = 40 \text{ mA}$	All Types
Clamped Switching	
$T_{A} = +25 \ ^{\circ}C$	
Test 1	
l <sub>B</sub> = 85 mA, l <sub>C</sub> = 500 mA	2N3498L, 2N3499L
$I_{B} = 50 \text{ mA}, I_{C} = 300 \text{ mA}$	2N3500L, 2N3501L



T4-LDS-0276-1, Rev. 1 (121221)



GRAPHS

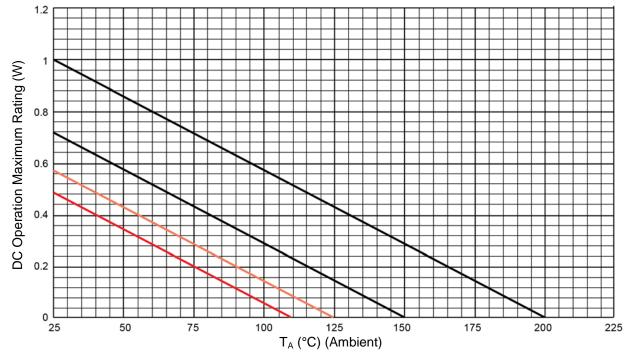


FIGURE 1

Derating for all devices ( $R_{\underline{\theta}JA}$ )

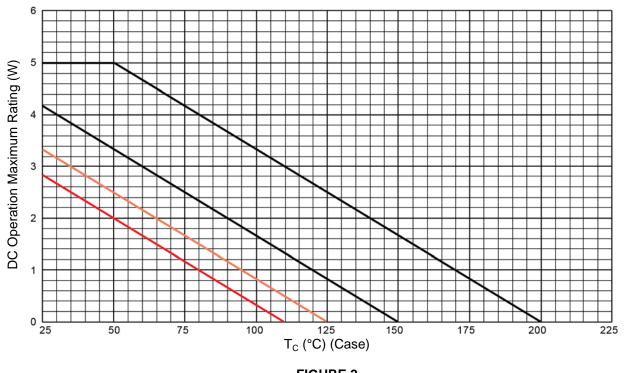
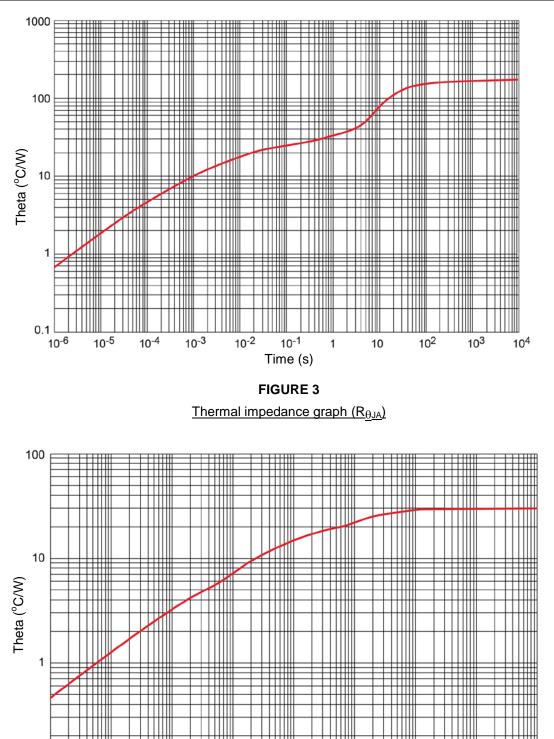


FIGURE 2 Derating for all devices  $(R_{\theta JC})$ 



GRAPHS



0.1 10<sup>-6</sup> TITII

10-4

10<sup>-5</sup>

10<sup>-2</sup>

Time (s)

FIGURE 4 Thermal impedance graph (R<sub>θJC</sub>)

10-1

10<sup>-3</sup>

10

1

10<sup>2</sup>

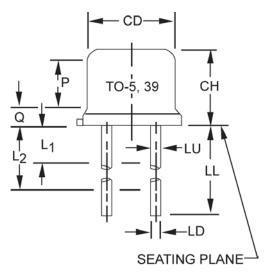
Downloaded from Arrow.com.

Note



## PACKAGE DIMENSIONS

Symbol



CD	0.305	0.335	7.75	8.51	
СН	0.240	0.260	6.10	6.60	
HD	0.335	0.370	8.51	9.40	
LC	0.20	0 TP	5.08	5 TP	6
LD	0.016	0.021	0.41	0.53	7
LL	S	See notes 7	7, 12 and 1	3	
LU	0.016	0.019	0.41	0.48	7, 13
L1		0.050		1.27	13
L2	0.250		6.35		13
Р	0.100		2.54		5
Q		0.050		1.27	4
TL	0.029	0.045	0.74	1.14	3
TW	0.028	0.034	0.71	0.86	10, 11
r		0.010		0.25	11
α	45° TP		45°	TP	6

Dimensions

Millimeters

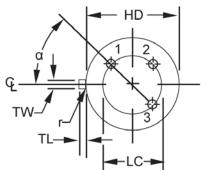
Max

Min

Inch

Max

Min



#### NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Symbol TL is measured from HD maximum.
- 4. Details of outline in this zone are optional.
- 5. Symbol CD shall not vary more than .010 (0.25 mm) in zone P. This zone is controlled for automatic handling.
- Leads at gauge plane .054 inch (1.37 mm) +.001 inch (0.03 mm) -.000 inch (0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) relative to tab. Device may be measured by direct methods or by gauge.
- 7. Symbol LD applies between L1 and L2. Dimension LD applies between L2 and LL minimum. Lead diameter shall not exceed .042 inch (1.07 mm) within L1 and beyond LL minimum.
- 8. Lead designation, shall be as follows: 1 emitter, 2 base, 3 collector.
- 9. Lead number three is electrically connected to case.
- 10. Beyond r maximum, TW shall be held for a minimum length of .011 inch (0.28 mm).
- 11. Symbol r applied to both inside corners of tab.
- For transistor types 2N3498, 2N3499, 2N3500, and 2N3501, LL = .50 inch (12.7 mm) minimum and .750 inch (19.1 mm) maximum. For transistor types 2N3498L, 2N3499L, 2N3500L, and 2N3501L, LL = 1.50 inches (38.1 mm) minimum and 1.750 inches (44.5 mm) maximum.
- 13. All three leads.
- 14. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi x$  symbology.